ABBODIATION CONNECTING ELECTRONICS INDUSTRIES® Material Composition © Copyright 2005. IPC, Bar international and Pan-Ameri	nockburn, Illinois. A	Il rights reserved un ntions.	nder both	This docume level parts, ti	ent is a declarati he declaration e	on of the substancompasses all	nces within the manufact lower level materials for	turer listed i which the n	tem. Note: it nanufacturer	f the item is an as has engineering	ssembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on			
Supplier Information												
Company name*	pany name* Company unique ID			Unique ID Authority			Respons	Response Date*				
onsemi	mi								2024-04-20			
Contact Name	Title - Contact]	Phone - Contact*				Email - Contact*			
Product-Env-Stewards	wards Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*	ized Representative* Title - Representative]	Phone - Representative*				Email - Representative*			
Product-Env-Stewards Product Enviro Compliance					NA				Product-Env-Stewards@onsemi.com			
Requester Item Number Mi	r Item Number	Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
LV	8740V-TLM-E Stepping motor drive		iver		2024-04-20	РНМ		:	350.0	mg	Each	
Manufacturing Proccess Information												
Terminal Plating / Grid Array Material	Terminal Base	Terminal Base Alloy J-		Rating	Peak Proc	ess Body Temp	erature Max Time at Pea	ak Temperat	ure Numb	er of Reflow Cyc	cles	
contains Bi	contains Bi CU Alloy 3				260	С	30	secon	ds 3			
Comments												
ATTENTION: MSL 3 Rated item requires Bake	and Dry Pack (after	electrical test)										
For more information regarding material compo	sition please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die 1	14.26	mg	Supplier	Silicon (Si)	7440-21-3		14.2072	mg
			Supplier	Polyimide	Proprietary Data		0.0528	mg
Die Attach 0	0.79	mg	Supplier	Silver (Ag)	7440-22-4		0.6715	mg
			Supplier	Epoxy resins	129915-35-1		0.1067	mg
			Supplier	Polybutadiene polymer	Proprietary Data		0.0119	mg
Lead Frame 123.0	123.0	mg	Supplier	Zinc (Zn)	7440-66-6		0.2337	mg
			Supplier	Iron (Fe)	7439-89-6		3.1857	mg
			Supplier	Copper (Cu)	7440-50-8		119.4084	mg
			Supplier	Phosphorus (P)	7723-14-0		0.1722	mg
Mold Compound-Black 20	206.66	mg		Brominated epoxy resin	proprietary data		2.0666	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		28.9324	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		4.1332	mg
			Supplier	Carbon Black (C)	1333-86-4		0.8266	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		166.568	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		4.1332	mg
Plating	3.85	mg	В	Bismuth (Bi)	7440-69-9		0.0231	mg
			Supplier	Tin (Sn)	7440-31-5		3.8269	mg
Wire Bond - Au	1.44	mg	Supplier	Gold (Au)	7440-57-5		1.44	mg